



Material Content Data Sheet				RoHS		(Malogen-Free		
Sales Product Name	TLE7251VLE			Issued		23. September 2015		
MA#	MA001224316							
Package	PG-TSON-8-1			Weight*		27.05 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.493	5.52	5.52	55184	55184
leadframe	inorganic material	phosphorus	7723-14-0	0.003	0.01		109	
	non noble metal	zinc	7440-66-6	0.012	0.04		436	
	non noble metal	iron	7439-89-6	0.236	0.87		8728	
	non noble metal	copper	7440-50-8	9.586	35.44	36.36	354409	363682
wire	non noble metal	copper	7440-50-8	0.035	0.13	0.13	1305	1305
encapsulation	organic material	carbon black	1333-86-4	0.029	0.11		1082	
	plastics	epoxy resin	-	1.507	5.57		55704	
	inorganic material	silicondioxide	60676-86-0	13.092	48.41	54.09	484034	540820
leadfinish	non noble metal	tin	7440-31-5	0.387	1.43	1.43	14307	14307
plating	noble metal	silver	7440-22-4	0.043	0.16	0.16	1607	1607
glue	plastics	epoxy resin	-	0.156	0.58		5774	
	noble metal	silver	7440-22-4	0.468	1.73	2.31	17321	23095
*deviation	< 10%				Sum in total:	100.00		1000000

## Important Remarks:

- 1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
- 2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
- 3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2011/65/EU (RoHS) and does not use any exemption.

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